# life.augmented

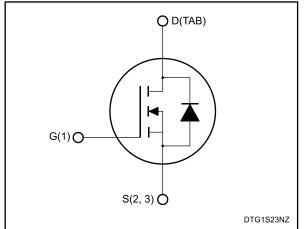
## STH15810-2

Datasheet - production data

## N-channel 100 V, 0.0034 Ω typ., 110 A, STripFET<sup>™</sup> F7 Power MOSFET in a H<sup>2</sup>PAK-2 package

TAB (2) 1 H<sup>2</sup>PAK-2

Figure 1: Internal schematic diagram



## Features

| Order code | VDS   | RDS(on)max | ID    | Ртот  |
|------------|-------|------------|-------|-------|
| STH15810-2 | 100 V | 0.0039 Ω   | 110 A | 250 W |

- 100% avalanche tested
- Ultra low on-resistance

#### **Applications**

• Switching applications

### Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

#### Table 1: Device summary

| Order code | Marking | Package              | Packaging     |
|------------|---------|----------------------|---------------|
| STH15810-2 | 15810   | H <sup>2</sup> PAK-2 | Tape and reel |

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This is information on a product in full production.

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## 1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol                         | Parameter   | Value         | Unit |  |
|--------------------------------|---|---------------|------|--|
| V <sub>DS</sub>                | Drain-source voltage                                  | 100           | V    |  |
| V <sub>GS</sub>                | Gate- source voltage                                  | ±20           | V    |  |
| ID                             | Drain current (continuous) at T <sub>C</sub> = 25 °C  | 110           | А    |  |
| ID                             | Drain current (continuous) at T <sub>C</sub> = 100 °C | 110           | А    |  |
| I <sub>DM</sub> <sup>(1)</sup> | Drain current (pulsed) T <sub>C</sub> = 25 °C         | 440           | А    |  |
| Ртот                           | Total dissipation at $T_c = 25 \text{ °C}$ 250        |               |      |  |
| Eas <sup>(2)</sup>             | Single pulse avalanche energy                         | 495           | mJ   |  |
| TJ                             | Operating junction temperature range                  | 55 to 175     | *0   |  |
| T <sub>stg</sub>               | Storage temperature range                             | -55 to 175 °C |      |  |

#### Notes:

 $^{(1)}Pulse$  width is limited by safe operating area  $^{(2)}Starting$  Tj=25 °C, ID=30 A, VDD=50 V

#### Table 3: Thermal data

| Symbol                              | Parameter                            | Value | Unit |
|-------------------------------------|--------------------------------------|-------|------|
| R <sub>thj</sub> -case              | Thermal resistance junction-case max | 0.6   | °C/W |
| R <sub>thj-pcb</sub> <sup>(1)</sup> | Thermal resistance junction-pcb max  | 35    | °C/W |

#### Notes:

 $^{(1)}\!When$  mounted on 1 inch² FR-4 board, 2 oz Cu



#### 2 **Electrical characteristics**

(Tc = 25 °C unless otherwise specified)

| Symbol                                  | Parameter   | Test conditions                                       | Min. | Тур.   | Max.   | Unit |
|---|---|---|------|--------|--------|------|
| $V_{(BR)DSS}$                           | Drain-source breakdown voltage  | $V_{GS}$ = 0, I <sub>D</sub> = 250 µA                 | 100  |        |        | V    |
|   |   | $V_{GS}$ = 0, $V_{DS}$ = 100 V                        |      |        | 1      | μA   |
| IDSS Zero gate voltage<br>drain current | $V_{GS} = 0,$<br>$V_{DS} = 100 \text{ V}, \text{ T}_{C}=125$<br>°C <sup>(1)</sup> |   |      | 100    | μA     |      |
| I <sub>GSS</sub>                        | Gate-body leakage current   | $V_{DS} = 0, V_{GS} = +20 V$                          |      |        | 100    | nA   |
| VGS(th)                                 | Gate threshold voltage  | $V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$               | 2.5  |        | 4.5    | V    |
| R <sub>DS(on)</sub>                     | Static drain-source on-<br>resistance   | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 55 \text{ A}$ |      | 0.0034 | 0.0039 | Ω    |

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#### Notes:

<sup>(1)</sup>Defined by design, not subject to production test.

| Symbol          | Parameter                    | Test conditions  | Min. | Тур. | Max. | Unit |
|-----------------|------------------------------|--|------|------|------|------|
| Ciss            | Input capacitance            |  | -    | 8115 | -    | pF   |
| Coss            | Output capacitance           | $V_{DS} = 50 V, f = 1 MHz,$                              | -    | 1510 | -    | pF   |
| Crss            | Reverse transfer capacitance | V <sub>GS</sub> = 0                                      | -    | 67   | -    | pF   |
| Qg              | Total gate charge            | V <sub>DD</sub> = 50 V, I <sub>D</sub> =110 A,           | -    | 117  | -    | nC   |
| Qgs             | Gate-source charge           | V <sub>GS</sub> = 10 V                                   | -    | 47   | -    | nC   |
| Q <sub>gd</sub> | Gate-drain charge            | (see Figure 14: "Test circuit for gate charge behavior") | -    | 26   | -    | nC   |

#### Table 5: Dynamic

#### **Table 6: Switching times**

| Symbol              | Parameter           | Test conditions                                | Min. | Тур. | Max. | Unit |
|---------------------|---------------------|--|------|------|------|------|
| t <sub>d(on)</sub>  | Turn-on delay time  | V <sub>DD</sub> = 50 V, I <sub>D</sub> = 55 A, | -    | 33   | -    | ns   |
| tr                  | Rise time           | $R_{G} = 4.7 \Omega, V_{GS} = 10 V$            | -    | 57   | -    | ns   |
| t <sub>d(off)</sub> | Turn-off delay time | (see Figure 13: "Test circuit for              | -    | 72   | -    | ns   |
| tf                  | Fall time           | resistive load switching times")               | -    | 33   | -    | ns   |



#### Electrical characteristics

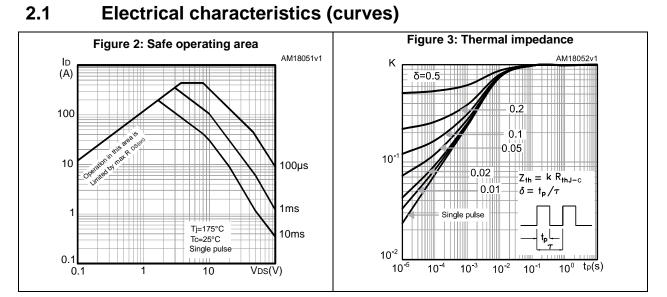
|                                 | Table 7: Source drain diode   |  |      |      |      |      |  |
|---------------------------------|-------------------------------|--|------|------|------|------|--|
| Symbol                          | Parameter                     | Test conditions  | Min. | Тур. | Max. | Unit |  |
| Isd                             | Source-drain current          |  | -    |      | 110  | А    |  |
| I <sub>SDM</sub> <sup>(1)</sup> | Source-drain current (pulsed) |  | -    |      | 440  | А    |  |
| Vsd <sup>(2)</sup>              | Forward on voltage            | I <sub>SD</sub> = 110 A, V <sub>GS</sub> = 0   | -    |      | 1.2  | V    |  |
| trr                             | Reverse recovery time         | I <sub>SD</sub> = 110 A, di/dt = 100 A/µs  | -    | 70   |      | ns   |  |
| Qrr                             | Reverse recovery charge       | V <sub>DD</sub> = 80 V, T <sub>J</sub> =150 °C (see<br><i>Figure 15: "Test circuit for</i> | -    | 165  |      | nC   |  |
| Irrm                            | Reverse recovery<br>current   | inductive load switching and<br>diode recovery times")                                     | -    | 4.7  |      | А    |  |

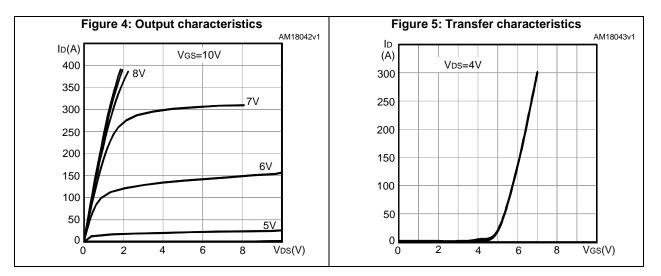
#### Notes:

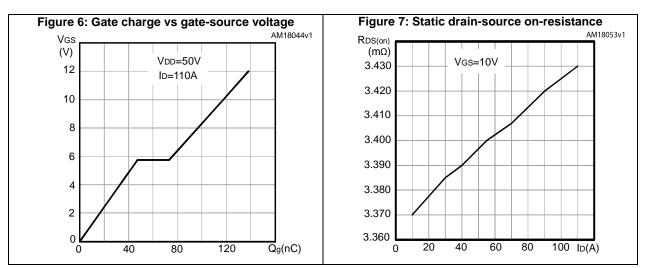
 $^{(1)}\mbox{Pulse}$  width limited by safe operating area

 $^{(2)}\text{Pulsed:}$  pulse duration = 300 µs, duty cycle 1.5%.







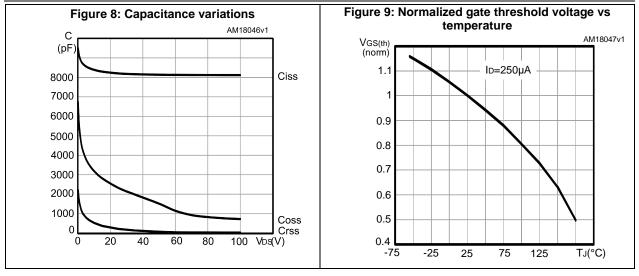


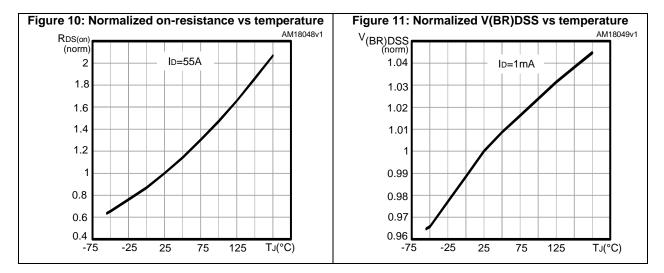
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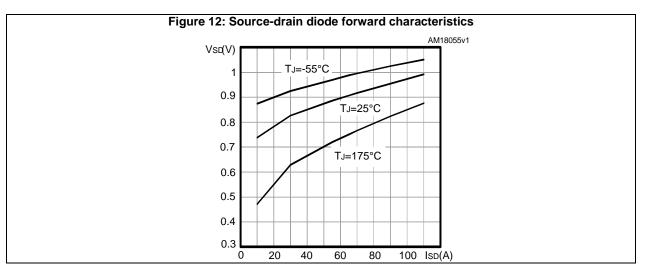
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#### **Electrical characteristics**



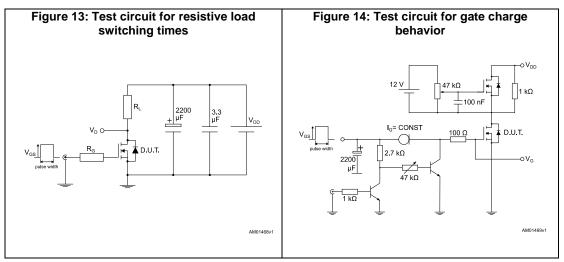


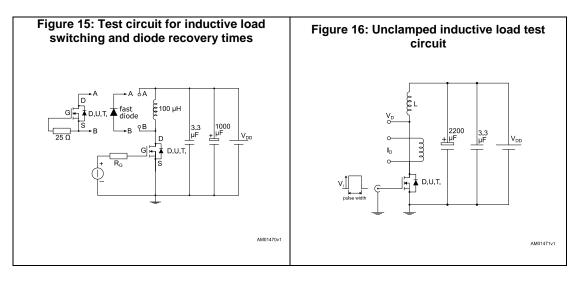


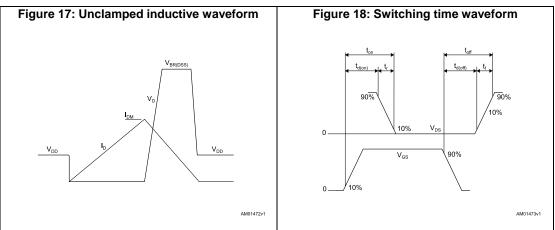
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## 3 Test circuits







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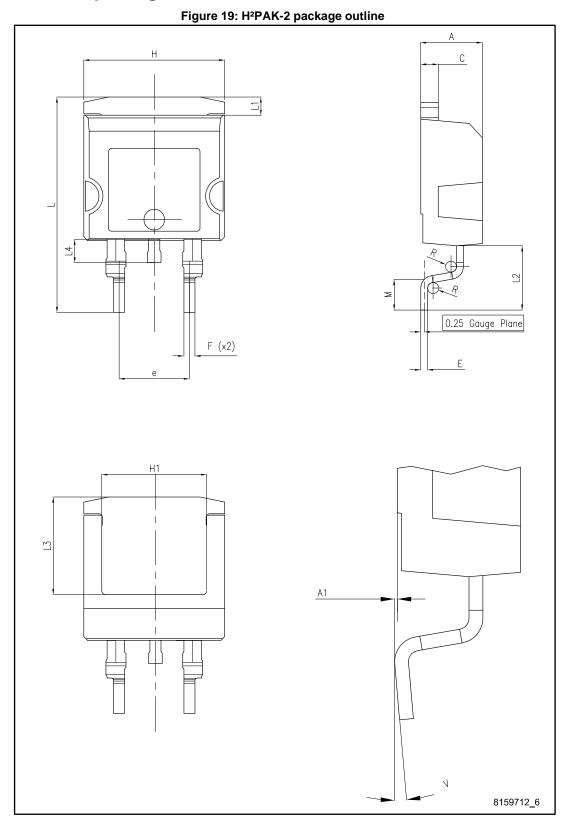
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## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



## 4.1 H<sup>2</sup>PAK-2 package information



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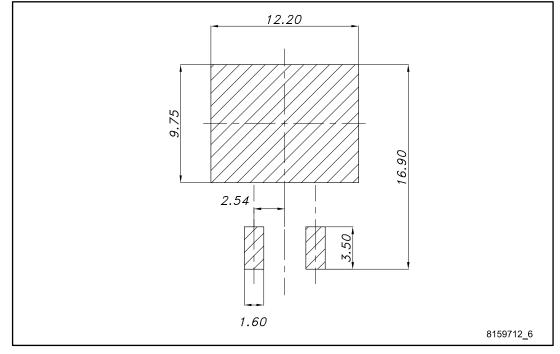
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#### Package information

| Table 8: H <sup>2</sup> PAK-2 package mechanical data |       |      |       |
|---|-------|------|-------|
| Dim.  |       | mm   |       |
| Dim.  | Min.  | Тур. | Max.  |
| A   | 4.30  |      | 4.70  |
| A1  | 0.03  |      | 0.20  |
| С   | 1.17  |      | 1.37  |
| e   | 4.98  |      | 5.18  |
| E   | 0.50  |      | 0.90  |
| F   | 0.78  |      | 0.85  |
| Н   | 10.00 |      | 10.40 |
| H1  | 7.40  |      | 7.80  |
| L   | 15.30 | -    | 15.80 |
| L1  | 1.27  |      | 1.40  |
| L2  | 4.93  |      | 5.23  |
| L3  | 6.85  |      | 7.25  |
| L4  | 1.5   |      | 1.7   |
| М   | 2.6   |      | 2.9   |
| R   | 0.20  |      | 0.60  |
| V   | 0°    |      | 8°    |

#### Figure 20: H<sup>2</sup>PAK-2 recommended footprint



4.2 H<sup>2</sup>PAK-2 packing information

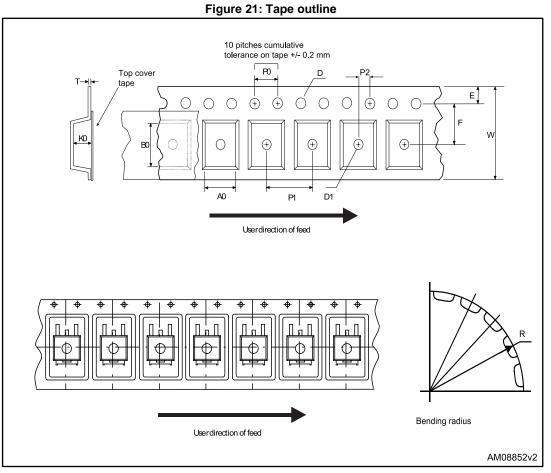
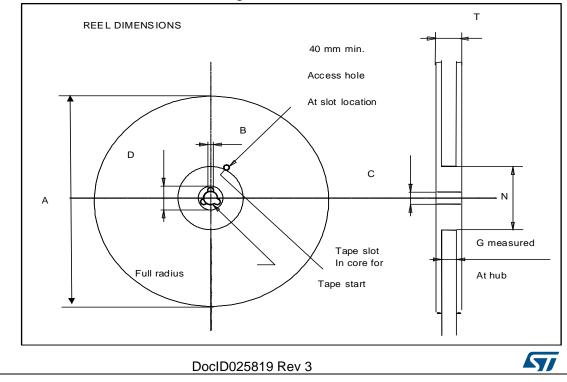


Figure 22: Reel outline



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#### Package information

|      | Та   | able 9: Tape and | d reel mechanical |          |      |
|------|------|------------------|-------------------|----------|------|
|      | Таре |                  |                   | Reel     |      |
| Dim. | m    | ım               | Dim.              | m        | m    |
| Dim. | Min. | Max.             |                   | Min.     | Max. |
| A0   | 10.5 | 10.7             | A                 |          | 330  |
| B0   | 15.7 | 15.9             | В                 | 1.5      |      |
| D    | 1.5  | 1.6              | С                 | 12.8     | 13.2 |
| D1   | 1.59 | 1.61             | D                 | 20.2     |      |
| E    | 1.65 | 1.85             | G                 | 24.4     | 26.4 |
| F    | 11.4 | 11.6             | Ν                 | 100      |      |
| K0   | 4.8  | 5.0              | Т                 |          | 30.4 |
| P0   | 3.9  | 4.1              |                   |          |      |
| P1   | 11.9 | 12.1             | Base              | quantity | 1000 |
| P2   | 1.9  | 2.1              | Bulk d            | quantity | 1000 |
| R    | 50   |                  |                   |          |      |
| Т    | 0.25 | 0.35             | ]                 |          |      |
| W    | 23.7 | 24.3             |                   |          |      |



## 5 Revision history

Table 10: Document revision history

| Date        | Revision | Changes   |
|-------------|----------|---|
| 22-Jan-2014 | 1        | First release. The part number previously included in datasheet DocID024972   |
| 25-Aug-2014 | 2        | Updated title and description in cover page.<br>Added E <sub>AS</sub> parameter in <i>Table 2: Absolute maximum ratings.</i><br>Minor text changes. |
| 11-Jan-2017 | 3        | Document status promoted from preliminary to production data.<br>Minor text changes.  |



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